

L Number	Hits	Search Text	DB	Time stamp
1	419	438/455,459.ccls. and oxidiz\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 13:48
2	13	((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) not (((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) and (N near2 buried))) and (oxidiz\$4 near3 ((both or second or two) near2 surface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 10:32
3	78	((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) not (((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) and (N near2 buried))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 12:17
4	84	(438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 12:17
5	335	(438/455,459.ccls. and oxidiz\$4) not ((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 12:17
6	12	("5256582") or ("4875086") or ("6146956") or ("5637516") or ("5814538") or ("5892264") or ("4897698") or ("5652153") or ("6225181") or ("6258641") or ("5633180") or ("5897362").PN.	USPAT	2004/03/09 13:49
7	1173	438/455,459.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 13:58
8	754	438/455,459.ccls. not (438/455,459.ccls. and oxidiz\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 13:58
9	29	(US-6403447-\$ or US-5004705-\$ or US-5849627-\$ or US-6362075-\$ or US-6194290-\$ or US-6153495-\$ or US-5918139-\$ or US-6583029-\$ or US-6534384-\$ or US-6420243-\$ or US-6372609-\$ or US-6306730-\$ or US-6284629-\$ or US-6245645-\$ or US-6171931-\$ or US-6004866-\$ or US-5855693-\$ or US-5770511-\$ or US-5413951-\$ or US-5308776-\$ or US-5227339-\$ or US-5213993-\$ or US-5194395-\$ or US-5032544-\$ or US-4888304-\$).did. or (US-20030162360-\$ or US-20020127823-\$ or US-20030134486-\$ or US-20030008478-\$).did.	USPAT; US-PGPUB	2004/03/09 13:59
10	2	(US-5194395-\$ or US-5213993-\$).did.	USPAT	2004/03/09 14:26
-	1171	438/455,459.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 13:58
-	419	438/455,459.ccls. and oxidiz\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 10:32

-	84	(438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 12:17
-	4	((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) and (N near2 buried)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/08 14:52
-	80	((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) not (((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) and (N near2 buried))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 10:32
-	13	((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) not (((438/455,459.ccls. and oxidiz\$4) and (handle near2 wafer)) and (N near2 buried))) and (oxidiz\$4 near3 ((both or second or two) near2 surface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/09 10:32